

TYN30W-800T

Rev.01 - 11 November 2022

**Product data sheet** 

### **1. General description**

Planar passivated Silicon Controlled Rectifier (SCR) in a TO247 plastic package intended for use in applications requiring very high inrush current capability, high thermal cycling performance and high junction temperature capability ( $T_{i(max)} = 150$  °C).

### 2. Features and benefits

- High junction operating temperature capability (T<sub>j(max)</sub> = 150 °C)
- · Very high current surge capability
- · Planar passivated for voltage ruggedness and reliability
- High thermal cycling performance
- High voltage capability

### 3. Applications

- Line rectifying 50/60 Hz
- Softstart AC motor control
- DC Motor control
- Power converter
- AC power control
- Lighting and temperature control
- Uninterruptible Power Supply (UPS)
  Solid State Bolov (SSB)
- Solid State Relay (SSR)Traction battery charging

# 4. Quick reference data

Symbol	Parameter	Conditions	Notes	Values	Unit
$V_{\text{DRM}}$	repetitive peak off-state voltage			800	V
I <sub>T(RMS)</sub>	RMS on-state current	half sine wave; T <sub>mb</sub> ≤ 137 °C; <u>Fig. 1; Fig. 2</u> ; <u>Fig. 3</u>		30	A
I <sub>TSM</sub>	non-repetitive peak on- state current	half sine wave; T <sub>j(init)</sub> = 25 °C; t <sub>p</sub> = 10 ms; <u>Fig 4</u> ; <u>Fig 5</u>		400	A
		half sine wave; $T_{j(init)}$ = 25 °C; $t_p$ = 8.3 ms		440	А
Tj	junction temperature			150	°C

Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static ch	aracteristics						
I <sub>GT</sub>	gate trigger current	$V_{\rm D}$ = 12 V; I <sub>T</sub> = 0.1 A; T <sub>j</sub> = 25 °C; <u>Fig. 7</u>		6	-	15	mA
I <sub>H</sub>	holding current	V <sub>D</sub> = 12 V; T <sub>j</sub> = 25 °C; <u>Fig. 9</u>		-	-	60	mA
V <sub>T</sub>	on-state voltage	I <sub>T</sub> = 30 A; T <sub>j</sub> = 25 °C; <u>Fig. 10</u>		-	1.10	1.30	V
		I <sub>T</sub> = 60 A; T <sub>j</sub> = 25 °C; <u>Fig. 10</u>		-	1.30	1.50	V
Dynamic	characteristics						
$dV_{\rm D}/dt$	rate of rise of off-state voltage	$V_{DM}$ = 402 V; T <sub>j</sub> = 150 °C; exponential waveform; gate open circuit		1000	-	-	V/µs

### 5. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	К	cathode		
2	A	anode		A H K G
3	G	gate		sym037
mb	A	mounting base; connected to anode		

# 6. Ordering information

Table 3. Ordering information							
Type number	Package Name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date	
TYN30W-800T	TO247	TYN30W-800TQ	Tube	30	TO247E	18-Jun-2021	

## 7. Marking

#### Table 4. Marking codes

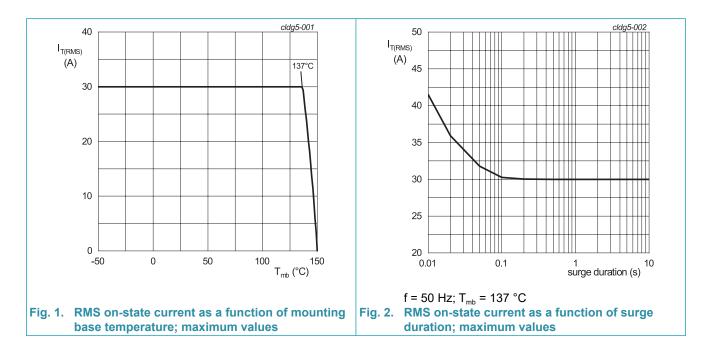
Type number	Marking codes
TYN30W-800T	TYN30W 800T

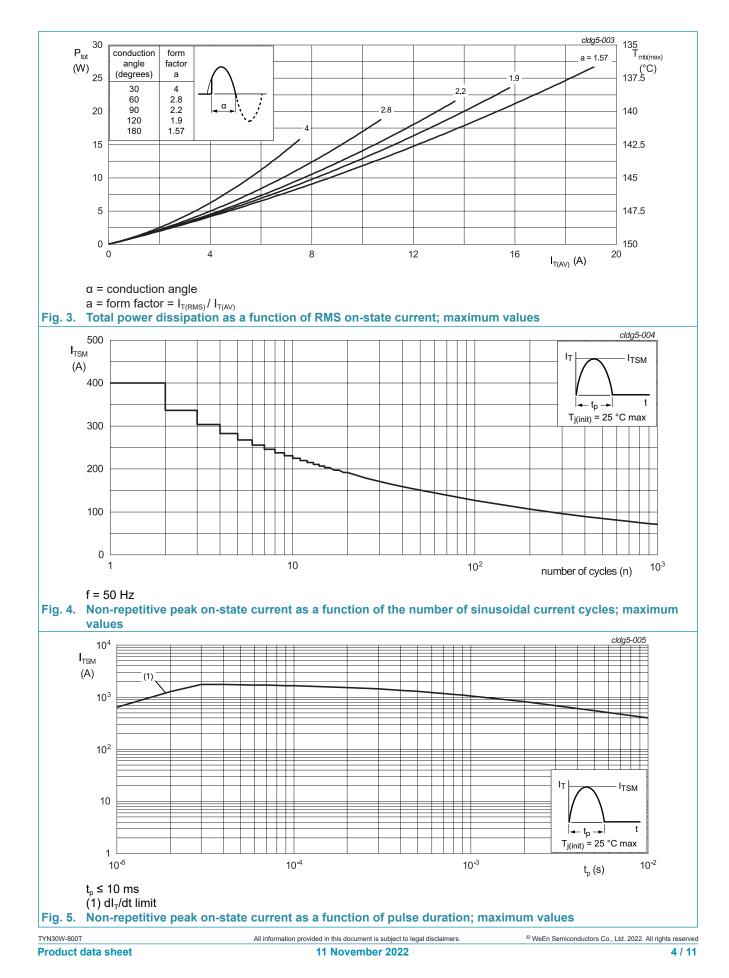
# 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

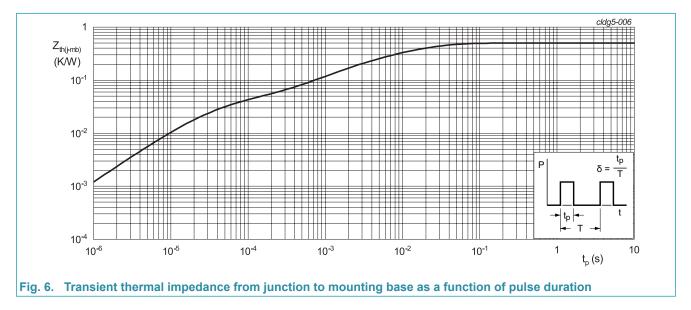
Symbol	Parameter	Conditions	Notes	Values	Unit
$V_{DRM}$	repetitive peak off-state voltage			800	V
$V_{RRM}$	repetitive peak reverse voltage			800	V
I <sub>T(AV)</sub>	average on-state current	half sine wave; T <sub>mb</sub> ≤ 137 °C;		19	А
I <sub>T(RMS)</sub>	RMS on-state current	half sine wave; T <sub>mb</sub> ≤ 137 °C; <u>Fig. 1; Fig. 2; Fig. 3</u>		30	A
I <sub>TSM</sub>	non-repetitive peak on- state current	half sine wave; $T_{j(init)}$ = 25 °C; $t_p$ = 10 ms; Fig 4; Fig 5		400	A
		half sine wave; $T_{j(init)}$ = 25 °C; $t_p$ = 8.3 ms		440	А
l²t	l <sup>2</sup> t for fusing	t <sub>p</sub> = 10 ms; sine-wave pulse		800	A <sup>2</sup> s
dl⊤/dt	rate of rise of on-state current	I <sub>G</sub> = 30 mA		200	A/µs
I <sub>GM</sub>	peak gate current			5	А
$V_{GM}$	peak gate voltage			5	V
V <sub>RGM</sub>	peak reverse gate voltage			7	V
P <sub>GM</sub>	peak gate power			20	W
P <sub>G(AV)</sub>	average gate power	over any 20 ms period		0.5	W
T <sub>stg</sub>	storage temperature			-40 to 150	°C
Ti	junction temperature			150	°C





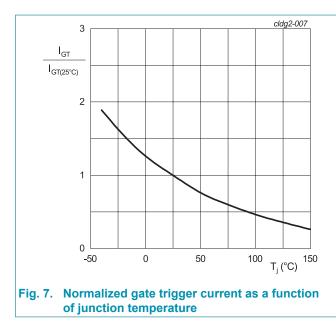
# 9. Thermal characteristics

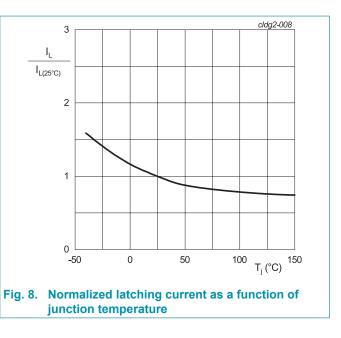
Table 6. Th	able 6. Thermal characteristics							
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit	
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	Fig 6		-	-	0.5	K/W	
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air		-	55	-	K/W	

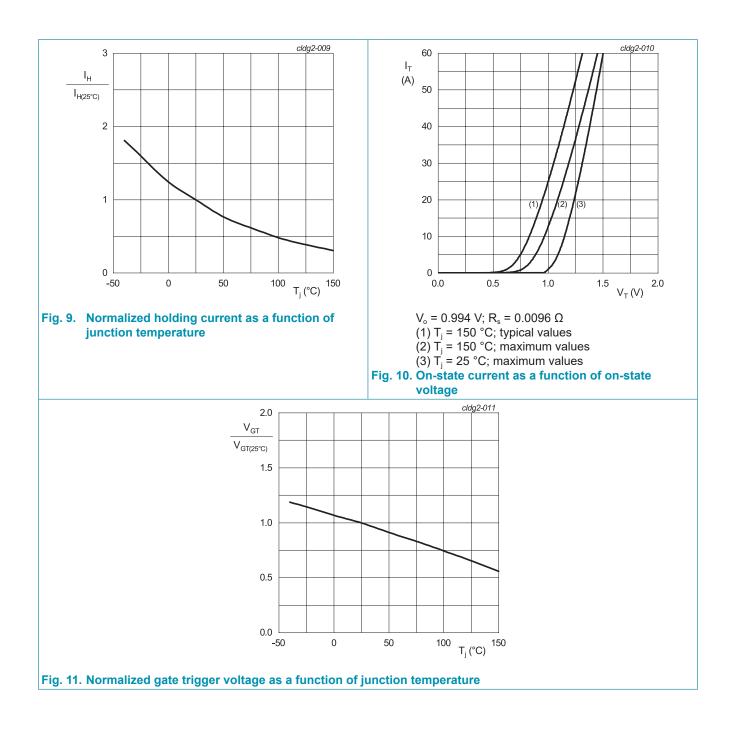


## **10. Characteristics**

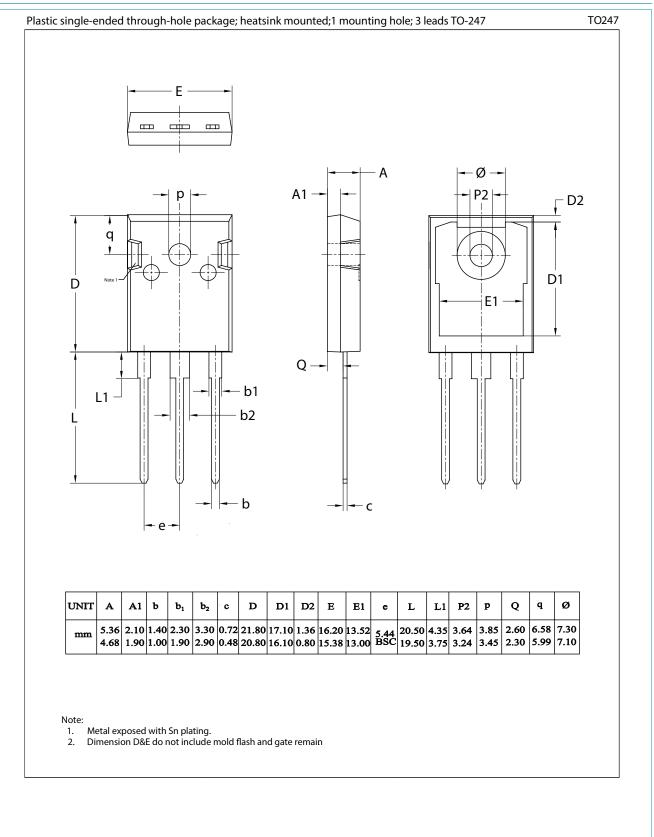
	naracteristics						
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static cha	racteristics						
I <sub>GT</sub>	gate trigger current	$V_{\rm D}$ = 12 V; I <sub>T</sub> = 0.1 A; T <sub>j</sub> = 25 °C; <u>Fig. 7</u>		6	-	15	mA
I <sub>L</sub>	latching current	$V_{\rm D}$ = 12 V; I <sub>G</sub> = 0.1 A; T <sub>j</sub> = 25 °C; <u>Fig. 8</u>		-	-	80	mA
I <sub>H</sub>	holding current	V <sub>D</sub> = 12 V; T <sub>j</sub> = 25 °C; <u>Fig. 9</u>		-	-	60	mA
V <sub>T</sub>	on-state voltage	I <sub>T</sub> = 30 A; T <sub>j</sub> = 25 °C; <u>Fig. 10</u>		-	1.10	1.30	V
		I <sub>T</sub> = 60 A; T <sub>j</sub> = 25 °C; <u>Fig. 10</u>		-	1.30	1.50	V
V <sub>GT</sub>	gate trigger voltage	V <sub>D</sub> = 12 V; I <sub>T</sub> = 0.1 A;T <sub>j</sub> = 25 °C; <u>Fig. 11</u>		-	0.6	1	V
		V <sub>D</sub> = 400 V; I <sub>T</sub> = 0.1 A;T <sub>j</sub> = 150 °C		0.25	0.4	-	V
I <sub>D</sub>	off-state current	V <sub>D</sub> = 800 V; T <sub>j</sub> = 25 °C		-	-	10	μA
		V <sub>D</sub> = 800 V; T <sub>j</sub> = 150 °C		-	-	1	mA
I <sub>R</sub>	reverse current	V <sub>R</sub> = 800 V; T <sub>j</sub> = 25 °C		-	-	10	μA
		V <sub>R</sub> = 800 V; T <sub>j</sub> = 150 °C		-	-	1	mA
Dynamic	characteristics	1					
dV <sub>D</sub> /dt	rate of rise of off-state voltage	$V_{DM}$ = 402 V; T <sub>j</sub> = 150 °C; exponential waveform; gate open circuit		1000	-	-	V/µs
		$V_{DM}$ = 536 V; T <sub>j</sub> = 150 °C; ( $V_{DM}$ = 67% of $V_{DRM}$ ); exponential waveform; gate open circuit		500	-	-	V/µs
t <sub>gt</sub>	gate-controlled turn-on time	$I_{TM} = 30 \text{ A}; V_D = 800 \text{ V}; I_G = 100 \text{ mA};$ $dI_G/dt = 5 \text{ A}/\mu\text{s}; T_j = 25 \text{ °C}$		-	2	-	μs
t <sub>q</sub>	commutated turn-off time	$V_{DM} = 536 \text{ V}; \text{ T}_{j} = 150 \text{ °C}; \text{ I}_{TM} = 30 \text{ A};$ $V_{R} = 25 \text{ V}; \text{ dI}_{T}/\text{dt} = 30 \text{ A}/\mu\text{s}; \text{ dV}_{D}/\text{dt} = 50 \text{ V}/\mu\text{s}$		-	70	-	μs







# 11. Package outline



# 12. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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- [2] The term 'short data sheet' is explained in section "Definitions".
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### 13. Contents

1.	General description	.1
2.	Features and benefits	.1
3.	Applications	.1
4.	Quick reference data	.1
5.	Pinning information	.2
6.	Ordering information	.2
7.	Marking	.2
8.	Limiting values	.3
9.	Thermal characteristics	.5
10	. Characteristics	.6
11	. Package outline	.8
12	. Legal information	.9
	. Contents	

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